

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	7399353
<b>Application Number:</b>	10578028
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	9578
<b>Title of Invention:</b>	Thin film diode panel and manufacturing method of the same
<b>First Named Inventor/Applicant Name:</b>	Kyoung-Ju Shin
<b>Customer Number:</b>	90323
<b>Filer:</b>	Kieun Sung-Ikegami/Robyne Orlando
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<b>Attorney Docket Number:</b>	PANK01883 US
<b>Receipt Date:</b>	12-APR-2010
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<b>Time Stamp:</b>	18:29:52
<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	PANK01883US_IDS_sb08_EF. pdf	620225 0f47416310de54ec029926f6d3669fc9afcd df4f	no	4

### Warnings:

### Information:

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2	Foreign Reference	PANK01883US_IDS_FR_JP0623 0435_EF.pdf	2162614 <small>241f12b07430d75b541784b6f26e5e4f3700ca26</small>	no	7
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**Warnings:**

**Information:**

3	Foreign Reference	PANK01883US_IDS_FR_JP0925 8263_EF.pdf	7282827 <small>4664194e7c5c3f0206500b187c0d052a87db43b2</small>	no	22
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